

General Description

The DS4125, DS4150, DS4155, DS4156, DS4160, DS4250, DS4300, DS4311, DS4312, DS4622, and DS4776 ceramic surface-mount crystal oscillators are part of Maxim's DS4-XO series of crystal oscillators. These devices offer output frequencies at 125MHz. 155.52MHz, 156.25MHz, 160MHz, 311.04MHz, 312.5MHz, 622.08MHz, and 77.76MHz. The clock oscillators are suited for systems with tight tolerances because of the jitter, phase noise, and stability performance. The small package provides a format made for applications where PCB space is critical.

These clock oscillators are crystal based and use a fundamental crystal with PLL technology to provide the final output frequencies. Each device is offered with LVDS or LVPECL output types. The output enable pin is active-high logic.

These clock oscillators have very low phase jitter and phase noise. Typical phase jitter is < 0.7ps_{RMS} from 12kHz to 20MHz. The devices are designed to operate with a 3.3V ±5% supply voltage, and are available in a 5.0mm x 3.2mm x 1.49mm, 10-pin LCCC surface-mount ceramic package.

Applications

InfiniBand

BPON/GPON

Ethernet

10GbE

SONET/SDH

Pin Configuration and Selector Guide appear at end of data sheet.

Features

- ♦ < 0.7ps_{RMS} from 12kHz to 20MHz Jitter
- **♦ LVDS or LVPECL Output Types**
- **♦ 3.3V Operating Voltage**
- ♦ 5.0mm x 3.2mm x 1.49mm, 10-Pin LCCC Ceramic **Package**
- ♦ -40°C to +85°C Operating Temperature Range
- **♦ Lead-Free/RoHS Compliant**

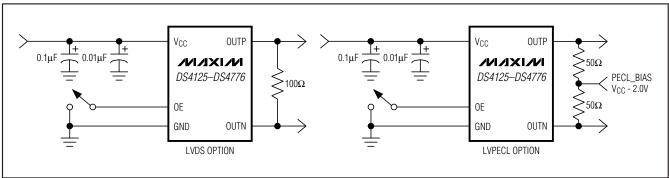
Ordering Information

PART	TEMP RANGE	PIN-PACKAGE
DS4125 D+	-40°C to +85°C	10 LCCC
DS4125P+	-40°C to +85°C	10 LCCC
DS4150 D+	-40°C to +85°C	10 LCCC
DS4150P+	-40°C to +85°C	10 LCCC
DS4155 D+	-40°C to +85°C	10 LCCC
DS4155P+	-40°C to +85°C	10 LCCC
DS4156 D+	-40°C to +85°C	10 LCCC
DS4156P+	-40°C to +85°C	10 LCCC
DS4160 D+	-40°C to +85°C	10 LCCC
DS4160P+	-40°C to +85°C	10 LCCC
DS4250 D+	-40°C to +85°C	10 LCCC
DS4250P+	-40°C to +85°C	10 LCCC
DS4300 D+	-40°C to +85°C	10 LCCC
DS4300P+	-40°C to +85°C	10 LCCC

⁺Denotes a lead(Pb)-free/RoHS-compliant package. The lead finish is JESD97 category e4 (Au over Ni) and is compatible with both lead-based and lead-free soldering processes.

Ordering Information continued at end of data sheet.

Typical Operating Circuits



MIXIM

ABSOLUTE MAXIMUM RATINGS

Power-Supply Voltage (V _{CC})0.3V, +4V	Storage Temperature Range55°C to +85°C
Operating Temperature Range40°C to +85°C	Soldering Temperature Profile
Junction Temperature+150°C	(3 passes max of reflow)Refer to the IPC/JEDEC
	J-STD-020 Specification.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

ELECTRICAL CHARACTERISTICS

($V_{CC} = 3.135V$ to 3.465V, $T_A = -40^{\circ}C$ to $+85^{\circ}C$, unless otherwise noted.)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Operating Voltage Range	Vcc	(Note 1)	3.135	3.3	3.465	V
	I _{CC_D}	LVDS, output loaded or unloaded		52	75	
Operating Current	ICC_PU	LVPECL, output unloaded		49	70] mA
	ICC_PI	LVPECL, output load 50Ω at V _{CC} - 2.0V		74	100	
Output Frequency	fout			f _{NOM}		MHz
Oscillator Startup Time	tstartup	(Note 2)			50	ms
Frequency Stability	Δ ftotal	Over temperature range, aging, load, supply, and initial tolerance (Note 3)	-50	fNOM	+50	ppm
Frequency Stability Over Temperature with Initial Tolerance	Δf_{TEMP}	V _{CC} = 3.3V	-35		+35	ppm
Initial Tolerance	Δ f $_{ m INITIAL}$	V _{CC} = 3.3V, T _A = +25°C		±20		ppm
Frequency Change Due to ΔV _{CC}	Δ f VCC	V _{CC} = 3.3V ±5%	-3		+3	ppm/V
Frequency Change Due to Load Variation	Δf_{LOAD}	±10% variation in termination resistance		±1		ppm
Aging (15 Years)	Δ faging		-7		+7	ppm
		Integrated phase RMS; 12kHz to 5MHz, V _{CC} = 3.3V, T _A = +25°C		0.7		
Jitter	JRMS	Integrated phase RMS; 12kHz to 20MHz, $V_{CC} = 3.3V$, $T_A = +25^{\circ}C$		0.7		ps
		Integrated phase RMS; 12kHz to 80MHz, V _{CC} = 3.3V, T _A = +25°C		1.0		
Input-Voltage High (OE)	VIH	(Note 1)	0.7 x VCC		Vcc	V
Input-Voltage Low (OE)	V_{IL}	(Note 1)	0		0.3 x V _C C	V
Input Leakage (OE)	ILEAK	GND ≤ OE ≤ V _{CC}	-50		+5.0	μΑ

ELECTRICAL CHARACTERISTICS (continued)

($V_{CC} = 3.135V$ to 3.465V, $T_A = -40^{\circ}C$ to $+85^{\circ}C$, unless otherwise noted.)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
LVDS			•			
Output High Voltage	Vohlvdso	100Ω differential load (Note 1)			1.475	V
Output Low Voltage	Vollydso	100Ω differential load (Note 1)	0.925			V
Differential Output Voltage	Vodevdso	100 $Ω$ differential load	250		425	mV
Output Common-Mode Voltage Variation	VLVDSOCOM	100Ω differential load			150	mV
Change in Differential Magnitude or Complementary Inputs	Δ Vodlvdso	100Ω differential load			25	mV
Offset Output Voltage	Vofflydso	100Ω differential load (Note 1)	1.125		1.275	V
Differential Output Impedance	Rolvdso		80		140	Ω
Output Current	Lvsslvdso	OUTN or OUTP shorted to ground and measure the current in the shorting path			40	mA
	L _{LVDSO}	OUTN or OUTP shorted together		6.5		1
Output Rise Time (Differential)	t _{RLVDSO}	20% to 80%		175		ps
Output Fall Time (Differential)	tFLVDSO	80% to 20%		175		ps
Duty Cycle	DCYCLE_LVDS		45		55	%
Propagation Delay from OE Going LOW to Logical 1 at OUTP	tPA1				200	ns
Propagation Delay from OE Going HIGH to Output Active	t _{P1A}				200	ns
LVPECL			I			1
Output High Voltage	V _{OH}	Output connected to 50Ω at PECL_BIAS at V _{CC} - 2.0V	V _{CC} - 1.085		V _{CC} - 0.88	V
Output Low Voltage	V _{OL}	Output connected to 50Ω at PECL_BIAS at V _{CC} - 2.0V	V _{CC} - 1.825		V _{CC} - 1.62	V
Differential Voltage	VDIFF_PECL	Output connected to 50Ω at PECL_BIAS at V _{CC} - 2.0V	0.595	0.710		V
Rise Time	t _{R-PECL}			200		ps
Fall Time	tF-PECL			200		ps
Duty Cycle	DCYCLE_PECL		45		55	%
Propagation Delay from OE Going LOW to Output High Impedance	t _{PAZ}				200	ns
Propagation Delay from OE Going HIGH to Output Active	t _{PZA}				200	ns

Note 1: All voltages referenced to ground.

Note 2: AC parameters are guaranteed by design and not production tested.

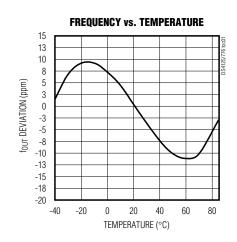
Note 3: Frequency stability is calculated as: $\Delta f_{TOTAL} = \Delta f_{TEMP} + \Delta f_{VCC} \times (3.3 \times 5\%) + \Delta f_{LOAD} + \Delta f_{AGING}$.

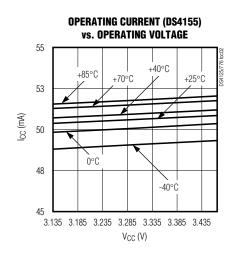
SINGLE-SIDEBAND PHASE NOISE AT fo = fnom

6 –	SINGLE-SIDEBAND PHASE NOISE AT f _O = f _{NOM} (dBc/Hz)							
f _M =	77.76MHz	125.00MHz	155.52MHz	156.25MHz	160.00MHz	311.04MHz	312.5MHz	622.08MHz
10Hz	-60	-70	-70	-70	-70	-65	-65	-60
100Hz	-95	-100	-100	-100	-100	-95	-95	-90
1kHz	-122	-120	-120	-120	-120	-113	-113	-107
10kHz	-126	-120	-120	-120	-120	-113	-113	-107
100kHz	-131	-125	-125	-125	-125	-118	-118	-113
1MHz	-143	-142	-142	-142	-142	-137	-137	-131
10MHz	-149	-149	-149	-149	-149	-149	-149	-147
20MHz	-153	-153	-153	-153	-153	-153	-153	-150

Typical Operating Characteristics

 $(V_{CC} = +3.3V, T_A = +25^{\circ}C, unless otherwise noted.)$





Pin Description

PIN	NAME	FUNCTION
1	OE	Active-High Output Enable. Has an internal pullup 100kΩ resistor.
2, 7–10	N.C.	No Connection. Must be floated.
3	GND	Ground
4	OUTP	Positive Output for LVPECL or LVDS
5	OUTN	Negative Output for LVPECL or LVDS
6	Vcc	Supply Voltage
_	EP	Exposed Paddle. Do not connect this pad or place exposed metal under the pad.

NIXI/N

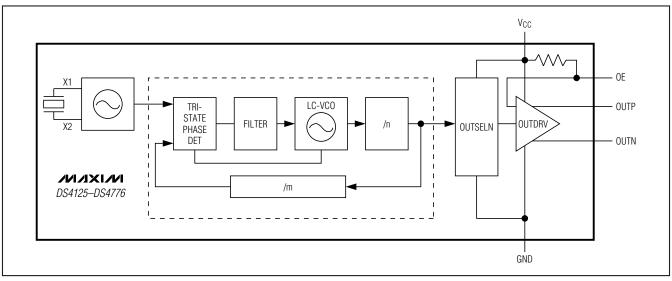


Figure 1. Functional Diagram

Detailed Description

The devices consist of a fundamental-mode, AT-cut crystal and a synthesizer IC that can synthesize any one of these frequencies: 77.76MHz, 125MHz, 150MHz, 155.52MHz, 156.25MHz, 160MHz, 250MHz, 300MHz, 311.04MHz, 312.5MHz, and 622.08MHz.

All devices support two types of differential output drivers: LVDS and LVPECL. When the OE signal is low,

LVPECL outputs go to the PECL_BIAS level of V_{CC} - 2.0V, while the LVDS outputs are a logical one. See Figures 2 and 3 for an LVDS and LVPECL output timing diagram.

Additional Information

For more available frequencies, refer to the DS4106 data sheet at www.maxim-ic.com/DS4106.

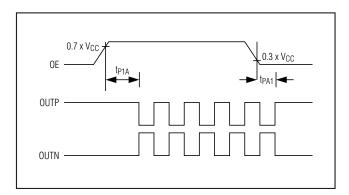


Figure 2. LVDS Output Timing Diagram When OE Is Enabled and Disabled

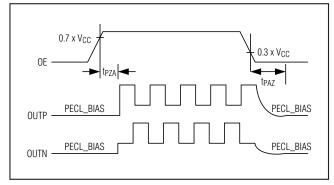


Figure 3. LVPECL Output Timing Diagram When OE Is Enabled and Disabled

Ordering Information (continued)

PART	TEMP RANGE	PIN-PACKAGE
DS4311 D+	-40°C to +85°C	10 LCCC
DS4311P+	-40°C to +85°C	10 LCCC
DS4312 D+	-40°C to +85°C	10 LCCC
DS4312P+	-40°C to +85°C	10 LCCC
DS4622 D+	-40°C to +85°C	10 LCCC
DS4622P+	-40°C to +85°C	10 LCCC
DS4776 D+	-40°C to +85°C	10 LCCC
DS4776P+	-40°C to +85°C	10 LCCC

⁺Denotes a lead(Pb)-free/RoHS-compliant package. The lead finish is JESD97 category e4 (Au over Ni) and is compatible with both lead-based and lead-free soldering processes.

_Chip Information

SUBSTRATE CONNECTED TO GROUND PROCESS: BiPOLAR SiGe

Thermal Information

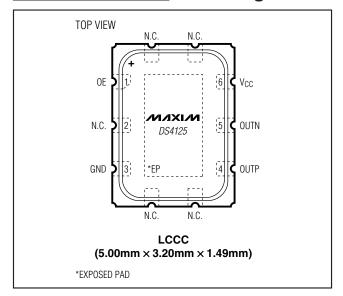
THETA-JA (°C/W)
90

Selector Guide

PART	FREQUENCY (NOM) (MHz)	FREQUENCY STABILITY (ppm)	OUTPUT TYPE	TOP MARK
DS4125D+	125.00	±50	LVDS	25D
DS4125P+	125.00	±50	LVPECL	25P
DS4150D+	150.00	±50	LVDS	50D
DS4150P+	150.00	±50	LVPECL	50P
DS4155D+	155.52	±50	LVDS	55D
DS4155P+	155.52	±50	LVPECL	55P
DS4156D+	156.25	±50	LVDS	56D
DS4156P+	156.25	±50	LVPECL	56P
DS4160D+	160.00	±50	LVDS	60D
DS4160P+	160.00	±50	LVPECL	60P
DS4250 D+	250.00	±50	LVDS	T5D
DS4250P+	250.00	±50	LVPECL	T5P
DS4300D+	300.00	±50	LVDS	30D
DS4300P+	300.00	±50	LVPECL	30P
DS4311 D+	311.04	±50	LVDS	31D
DS4311P+	311.04	±50	LVPECL	31P
DS4312D+	312.50	±50	LVDS	32D
DS4312P+	312.50	±50	LVPECL	32P
DS4622D+	622.08	±50	LVDS	62D
DS4622P+	622.08	±50	LVPECL	62P
DS4776 D+	77.76	±50	LVDS	76D
DS4776P+	77.76	±50	LVPECL	76P

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Pin Configuration



Package Information

For the latest package outline information and land patterns, go to **www.maxim-ic.com/packages**.

PACKAGE TYPE	PACKAGE CODE	DOCUMENT NO.
10 LCCC	L1053+H2	21-0389

Revision History

REVISION NUMBER	REVISION DATE	DESCRIPTION	PAGES CHANGED
0	7/07	Initial release.	_
1		Added DS4150, DS4250, DS4300.	All
	3/08	Removed $\Delta f_{\text{INITIAL}}$ from the frequency stability calculation in Note 3.	3
3,00		In the <i>Pin Description</i> , changed the EP description to indicate that it should not be connected and to avoid placing exposed metal under the pad location.	4
2	6/08	Removed future status from the DS4150, DS4250, and DS4300.	1, 6

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